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103378234

PATENTS ONLY

DEPARTMENT OF COMMERCE
Patent and Trademark Office

Attorney Docket No.: 46884-5533

FORM PTO-1595
(Rev. 6-93)

To the Commissioner for Patents **ATTN: MAIL STOP ASSIGNMENT RECORDATION SERVICES**
Please record the attached original documents or copy thereof.

2.28.07

1. Name of conveying party(ies):

1) Toshiyuki MAJIMA
2) Akira SHIMASE
3) Hirotohi TERADA
4) Kazuhiro HOTTA

Additional names of conveying party(ies) attached?
 Yes No

2. Name and address of receiving party(ies):

Name: HAMAMATSU PHOTONICS K.K.

Address: 1126-1, Ichino-cho,
Hamamatsu-shi, Shizuoka 435-8558 Japan

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: (1) February 15, 2007; (2) February 14, 2007; (3-4) February 9, 2007

Additional name(s) & address(es) attached?
 Yes No

4. New Application number(s) or patent number(s):
If this document is being filed together with a new application the execution date of the application is:

A. Patent Application No.(s) 11/586,721 B. Patent No.(s)

Additional numbers attached: Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: John G. Smith

Internal Address: DRINKER BIDDLE & REATH LLP
Customer No. 55694

Street Address: 1500 K. Street, N.W., Suite 1100
City: Washington State: D.C. Zip: 20005-1209

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. §3.41): \$40.00
 Enclosed
 Authorized to be charged to Deposit Account 50-0573

8. Deposit Account No. 50-0573
(Attach duplicate page if paying by deposit account)

9. Statement and Signature
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Peter J. Sistare, Reg. No. 48,183
Name of Person Signing

Signature

February 28, 2007
Date

Total number of pages including cover sheet, attachments and documents: 2

03/01/2007 10:00:01 103378234 11586721
03/01/2007 (10.18.07)

ASSIGNMENT

Whereas, I/we,

NameAddress1) **Toshiyuki MAJIMA**c/o Renesas Technology Corp.,
20-1, Josuihon-cho, 5 chome,
Kodaira-shi, Tokyo 187-8588 Japan2) **Akira SHIMASE**c/o Renesas Technology Corp.,
20-1, Josuihon-cho, 5 chome,
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c/o Hamamatsu Photonics K.K.,3) **Hirotooshi TERADA**1126-1, Ichino-cho,
Hamamatsu-shi, Shizuoka 435-8558 Japan
c/o Hamamatsu Photonics K.K.,4) **Kazuhiro HOTTA**1126-1, Ichino-cho,
Hamamatsu-shi, Shizuoka 435-8558 Japan

hereinafter called assignor(s), have invented certain improvements in
SEMICONDUCTOR FAILURE ANALYSIS APPARATUS, FAILURE ANALYSIS METHOD, AND FAILURE ANALYSIS PROGRAM

and executed an application for Letters Patent of the United States of America therefor on even date herewith unless otherwise indicated below:

filed on October 26, 2006, Serial No. 11/586721; and

Whereas

HAMAMATSU PHOTONICS K.K.1126-1, Ichino-cho,
Hamamatsu-shi, Shizuoka 435-8558 Japan

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

INVENTORSDATE SIGNED1): Toshiyuki Majima
Name: Toshiyuki MAJIMAFeb. 15, 20072): Akira Shimase
Name: Akira SHIMASEFeb. 14, 20073): Hirotooshi Terada
Name: Hirotooshi TERADAFeb. 9, 20074): Kazuhiro Hotta
Name: Kazuhiro HOTTAFeb. 9, 2007

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)